

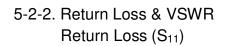
# 5. Layout Guide & Electrical Specifications 5-1. Layout Guide (unit : mm) Solder Land Pattern: The solder land pattern (gray marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions. With 150 x 100 mm<sup>2</sup> Evaluation Board Grounding pin Signal input 17 14.6 14.6 12.6 11.2 3.4 3.4 3.4 30 **Top View Bottom View** Transmission Line with 50Ω Impedance Characteristic With 80 x 40 mm<sup>2</sup> Evaluation Board Grounding pin Signal input 6.8 6.8 1.8 1.8 3.4 1.8 3.2 3.2 Bottom View Unictron **Top View** 2020-07-07 Transmission Line with 50Ω Impedance Characteristic Document ontrol Cent THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR Unictron Technologies Corporation SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION Website:www.unictron.com Prepared by :Jane Designed by : George Checked by : Mike Approved by : Herbert DOCUMENT TITLE: 5.0 x 3.0 x 0.5 (mm) ISM 433MHz Ceramic Chip REV. H2U64U1H2J0100 Antenna (C4501) Engineering Specification NO. D

5-2. Electrical Specifications (Evaluation Board Dimensions:150 x 100 mm<sup>2</sup>) 5-2-1. Electrical Table

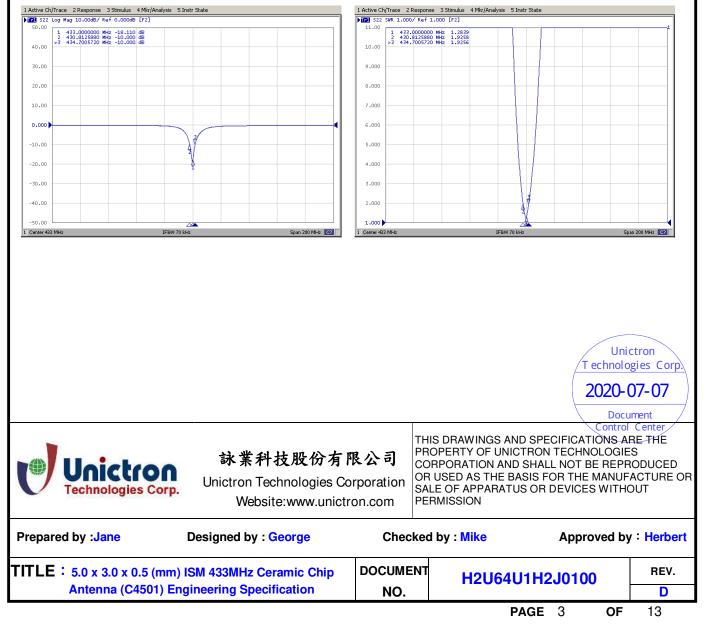
Characteristics		Specifications	Unit
Outline Dimensions		5.0 x 3.0 x 0.5	mm
Ground Plane Dimensions		150 x 100	mm
Working Frequency		433.05 ~ 434.79	MHz
VSWR (@ center frequency)*		2 Max.	
Characteristic Impedance		50	Ω
Polarization		Linear Polarization	
Peak Gain		0.2 (typical)**	dBi
Efficiency	- (@ 433 MHz)	62 (typical)**	%

\*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.

\*\*A Typical value is for reference only, not guaranteed.







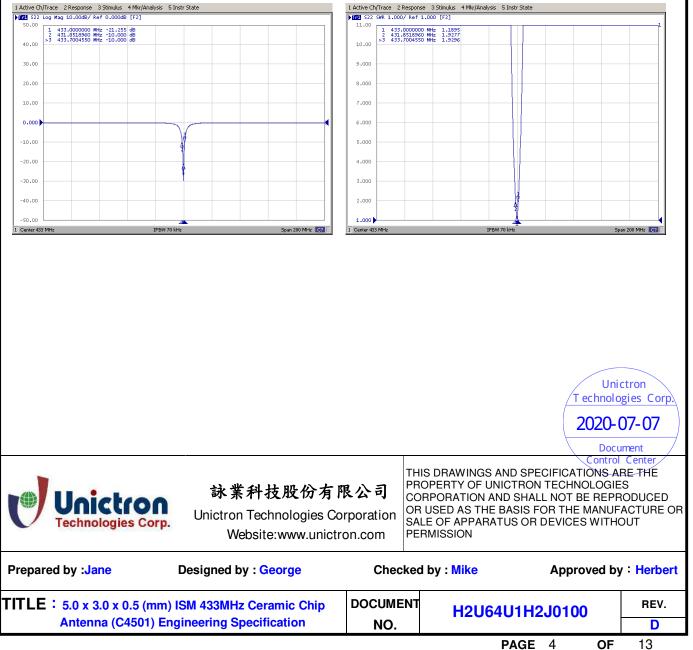
5-3. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm <sup>2</sup> ) 5-3-1. Electrical Table						
Char	Characteristics Specifications					
Ground Plane D	Dimensions	80 x 40	mm			
Working Freque	ency	433.05 ~ 434.79	MHz			
VSWR (@ center	er frequency)*	2 Max.				
Characteristic Ir	npedance	50	Ω			
Polarization		Linear Polarization				
Peak Gain	(@ 422 MU-)	-7.3 (typical)**	dBi			
Efficiency	– (@ 433 MHz)	12 (typical)**	%			

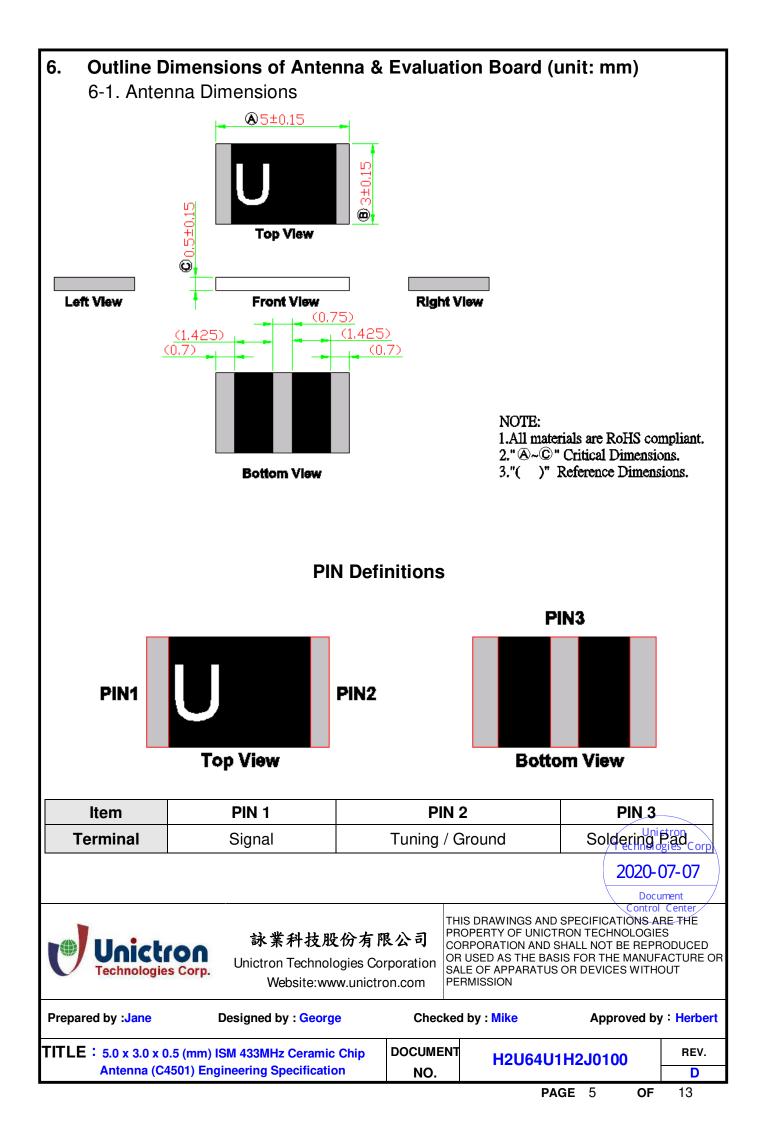
\*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.

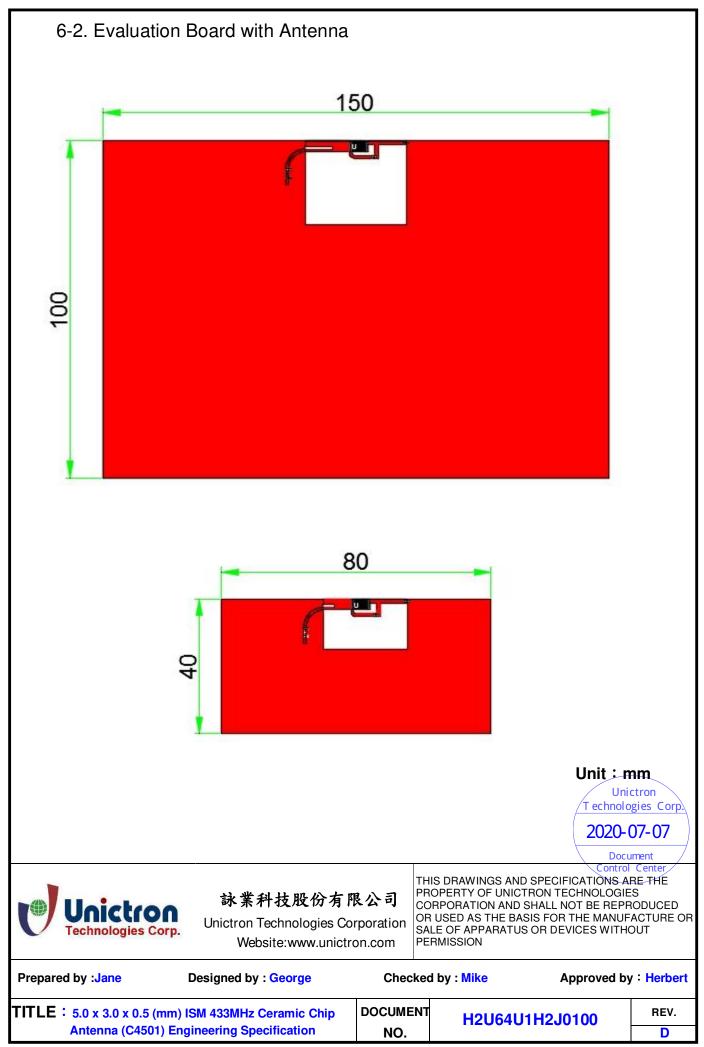
VSWR (S<sub>11</sub>)

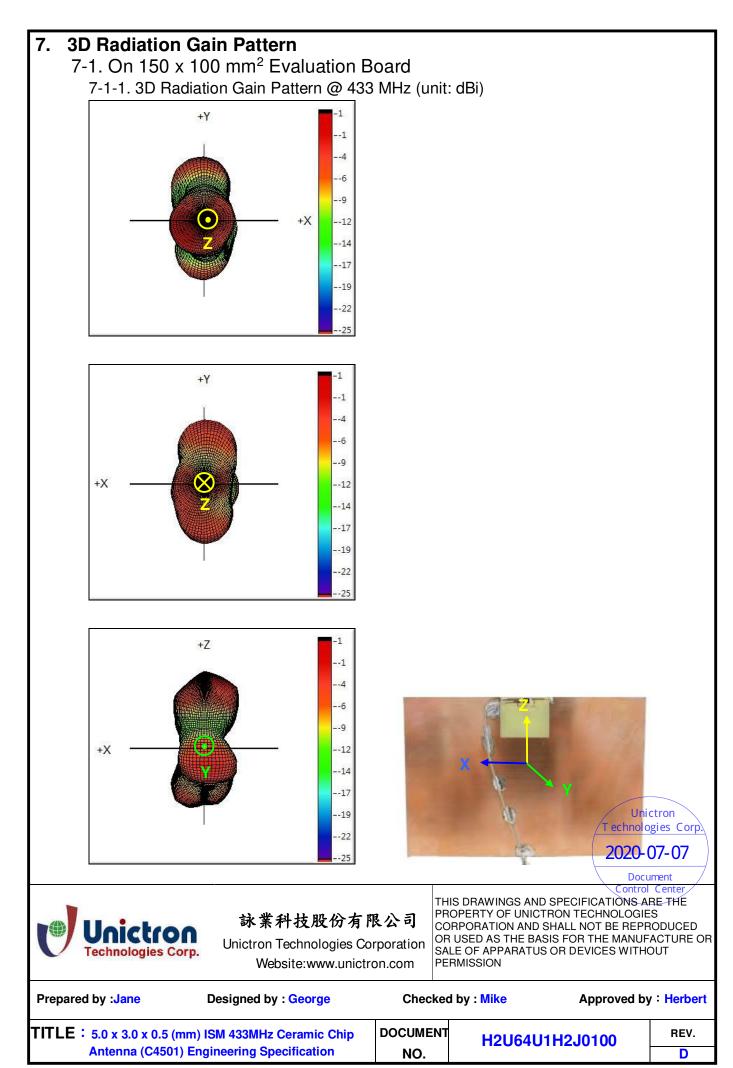
\*\*A Typical value is for reference only, not guaranteed.

## 5-3-2. Return Loss & VSWR Return Loss (S<sub>11</sub>)



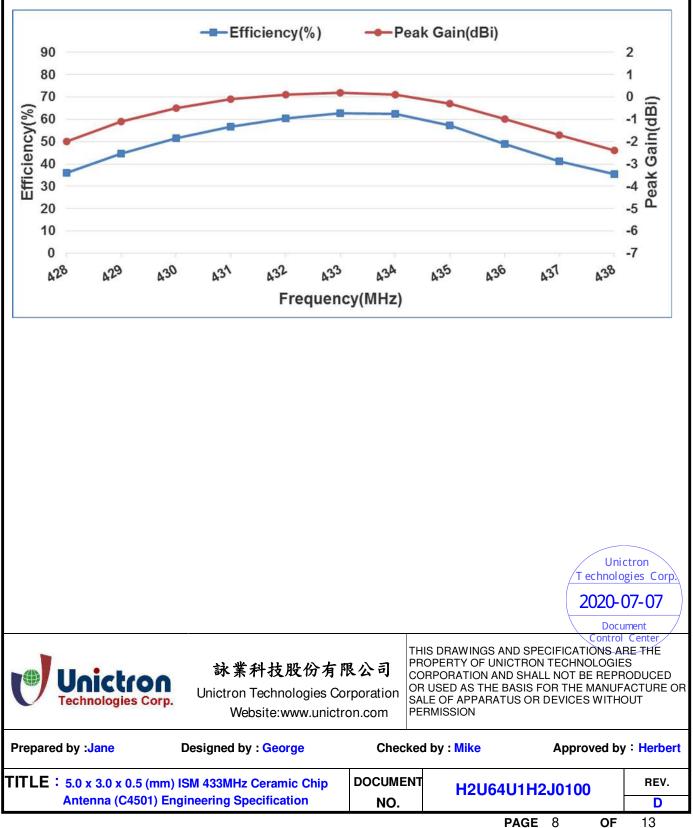


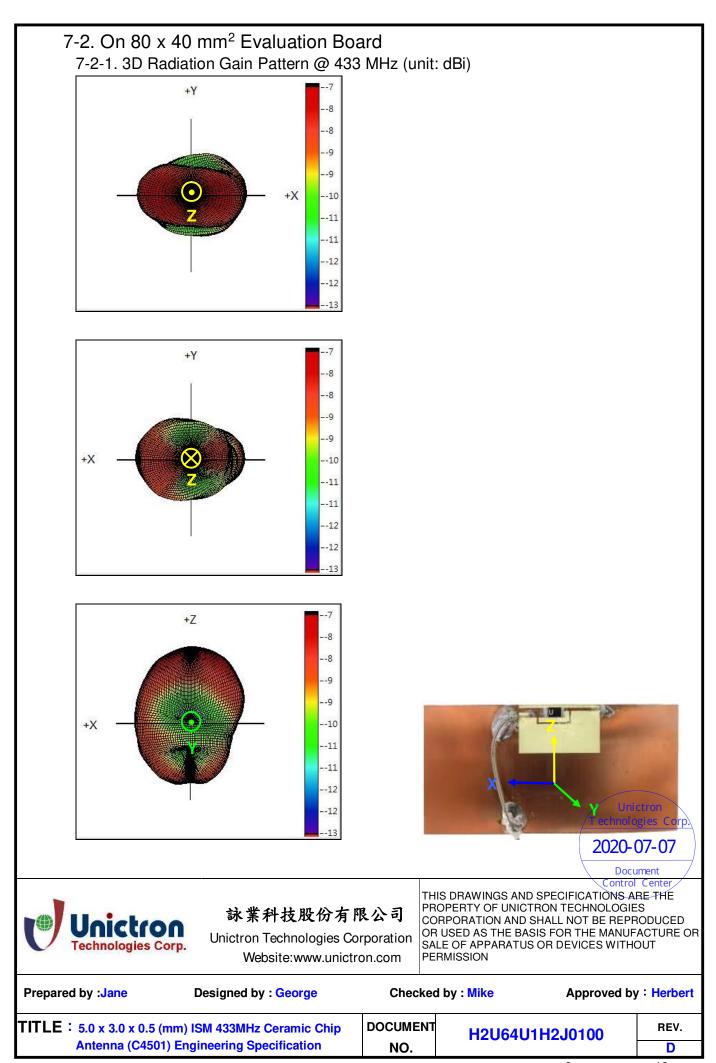




7-1-2. 3D Efficiency Table											
Frequency (MHz)	428	429	430	431	432	433	434	435	436	437	438
Efficiency (dB)	-4.4	-3.5	-2.9	-2.5	-2.2	-2.0	-2.1	-2.4	-3.1	-3.9	-4.5
Efficiency (%)	36.1	44.6	51.6	56.6	60.3	62.8	62.4	57.2	49.0	41.2	35.3
Peak Gain (dBi)	-2.0	-1.1	-0.5	-0.1	0.1	0.2	0.1	-0.3	-1.0	-1.7	-2.4

### 7-1-3. 3D Efficiency vs. Frequency

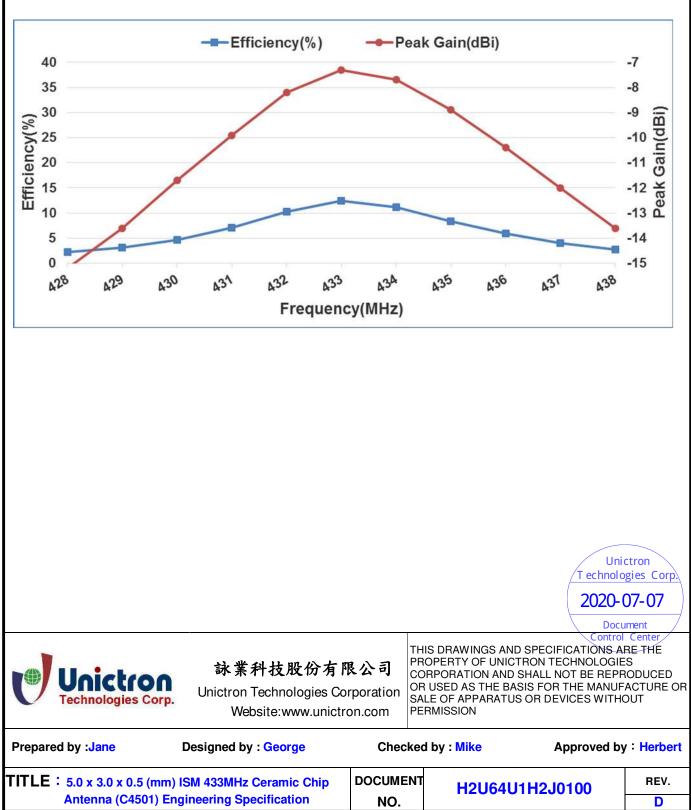


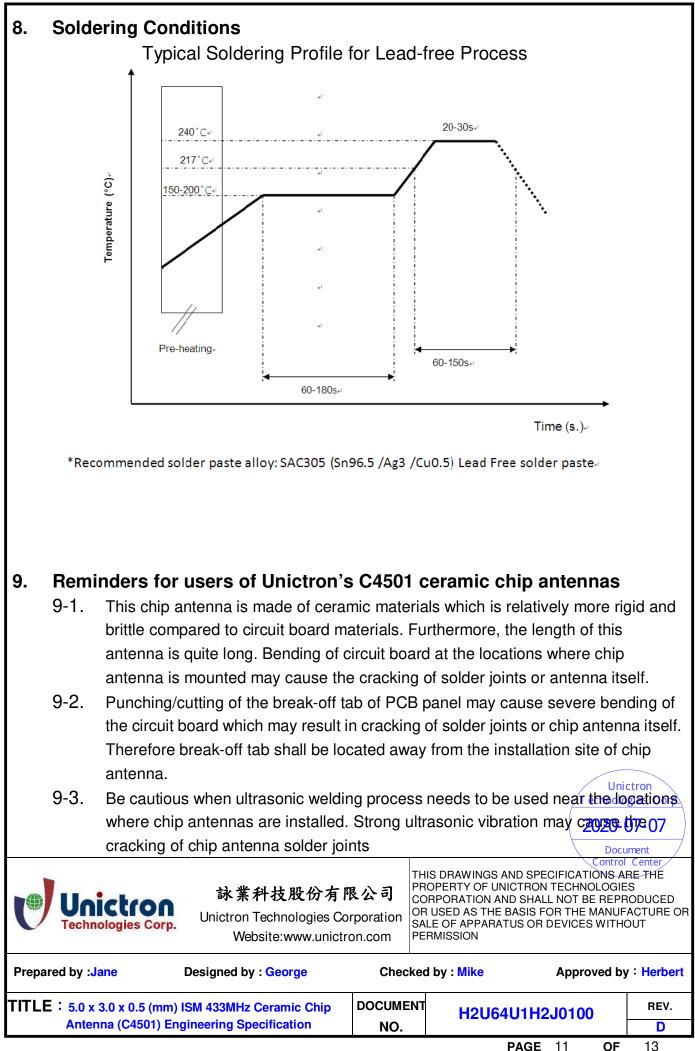


7-2-2. 3D Efficiency Table

,											
Frequency (MHz)	428	429	430	431	432	433	434	435	436	437	438
Efficiency (dB)	-16.7	-15.1	-13.3	-11.5	-9.9	-9.1	-9.5	-10.8	-12.3	-14.0	-15.6
Efficiency (%)	2.2	3.1	4.7	7.1	10.3	12.4	11.2	8.4	5.9	4.0	2.7
Peak Gain (dBi)	-15.2	-13.6	-11.7	-9.9	-8.2	-7.3	-7.7	-8.9	-10.4	-12.0	-13.6

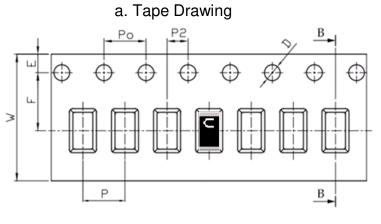
### 7-2-3. 3D Efficiency vs. Frequency





#### 10. Packing

- (1) Quantity/Reel: 6000 pcs/Reel
- (2) Plastic tape:



b. Tape Dimensions (unit: mm)

Feature	Specifications	Tolerances			
W	12.00	±0.30			
Р	8.00	±0.10			
Е	1.75	±0.10			
F	5.50	±0.10			
P2	2.00	±0.10			
D	1.20	+0.10			
D	1.20	-0.00			
Po	4.00	±0.10			
10Po	40.00	±0.20			
<b>1</b>		-			

#### 11. **Operating & Storage Conditions**

- 11-1. Operating
  - (1) Maximum Input Power: 2 W
  - (2) Operating Temperature:  $-40^{\circ}$ C to  $85^{\circ}$ C
  - (3) Relative Humidity: 10% to 70%
- 11-2. Storage (sealed)
  - (1) Storage Temperature:  $-5^{\circ}$ C to  $40^{\circ}$ C
  - (2) Relative Humidity: 20% to 70%
  - (3) Shelf Life: 1 year

## 11-3. Storage (unsealed)

Meet the criteria of J-STD-033 MSL2a

# 11-4. Storage (After mounted on customer's PCB with SMT process)

- (1) Storage Temperature:  $-40^{\circ}$ C to  $85^{\circ}$ C
- (2) Relative Humidity: 10% to 70%



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Prepared by :Jane	Designed by : George	Checked	l by : <mark>Mike</mark>	Approved by : Herber			
TITLE : 5.0 x 3.0 x 0.5 (mm) ISM 433MHz Ceramic Chip		DOCUMENT	H2U64U1H	0	REV.		
Antenna (C450	1) Engineering Specification	NO.			·	D	
			PAGE	12	OF	13	

#### 12. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

